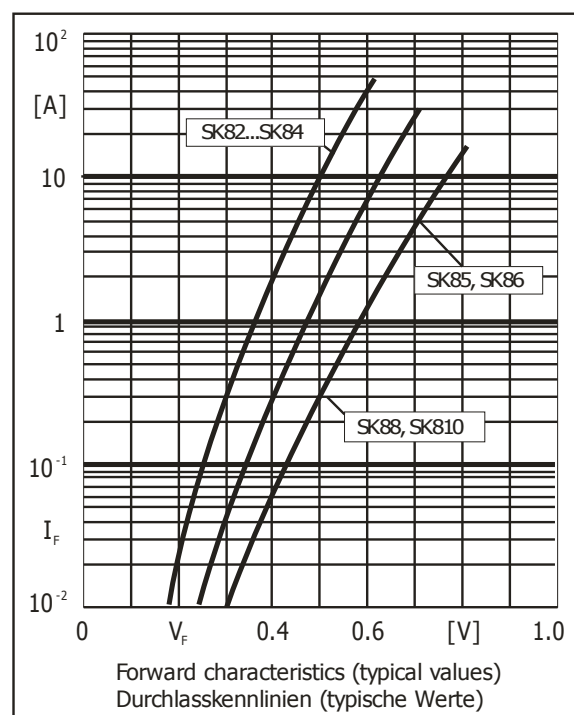
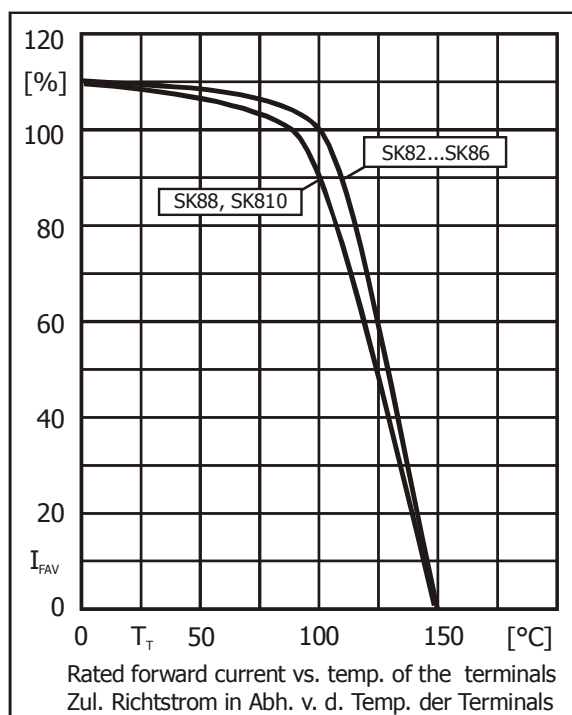


Characteristics

Kennwerte

Leakage current Sperrstrom	$T_j = 25^\circ\text{C}$ $T_j = 100^\circ\text{C}$	$V_R = V_{RRM}$ $V_R = V_{RRM}$	I_R I_R	$< 200 \mu\text{A}$ $< 20 \text{ mA}$
Thermal resistance junction to ambient air Wärmewiderstand Sperrschicht – umgebende Luft				R_{thA} $< 40 \text{ K/W}^{1)}$
Thermal resistance junction to terminal Wärmewiderstand Sperrschicht – Anschluss				R_{thT} $< 10 \text{ K/W}$



1 Mounted on P.C. board with 50 mm² copper pads at each terminal
Montage auf Leiterplatte mit 50 mm² Kupferbelag (Löt-pad) an jedem Anschluss